



GP
ELECTRONICS

GP3139KDW

20V Dual P-Channel MOSFET

Product Summary

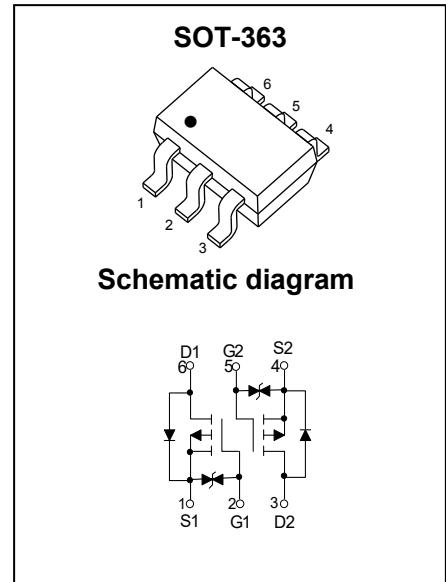
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-20V	400m Ω @-4.5V	-0.66A
	570m Ω @-2.5V	
	810m Ω @-1.8V	

Feature

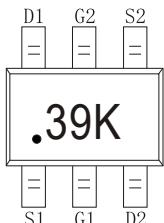
- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- ESD Protected

Application

- Load Switching
- Low Current Inverters
- Low Current DC/DC Converters



MARKING:



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V_{DS}	-20	V
Gate - Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^{1,5}	I_D	-0.66	A
Pulsed Drain Current ²	I_{DM}	-2.0	A
Power Dissipation ^{4,5}	P_D	0.3	W
Thermal Resistance from Junction to Ambient ⁵	$R_{\theta JA}$	416	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

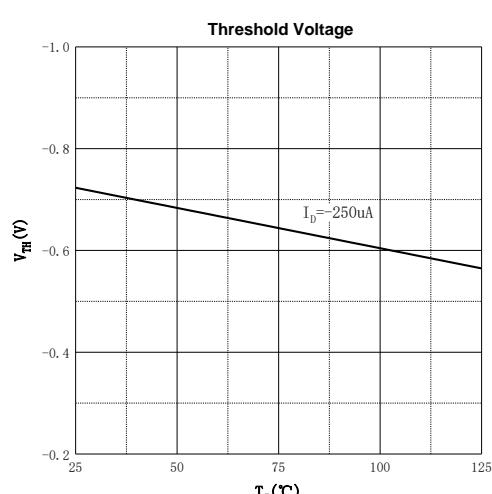
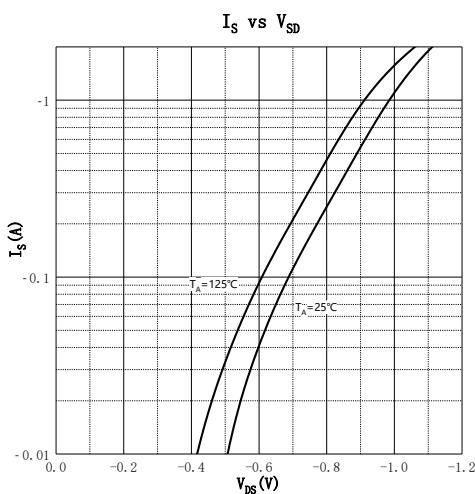
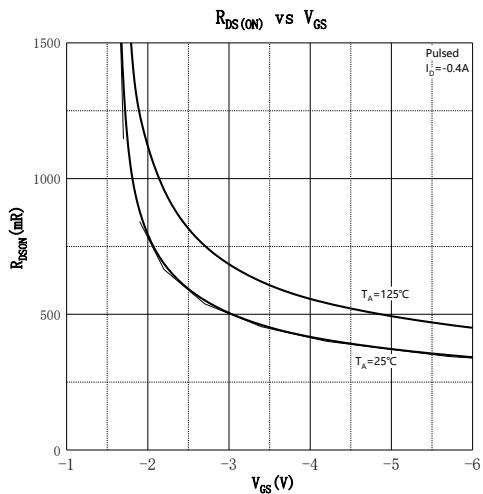
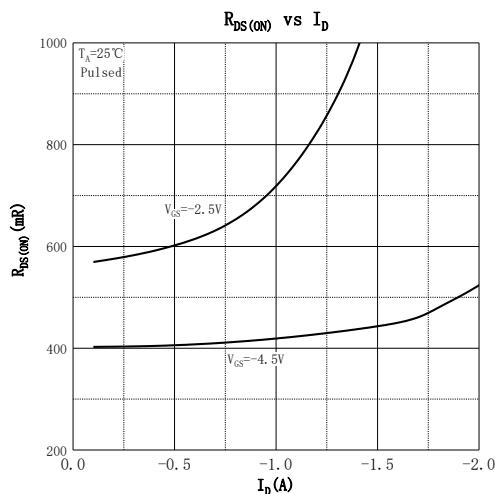
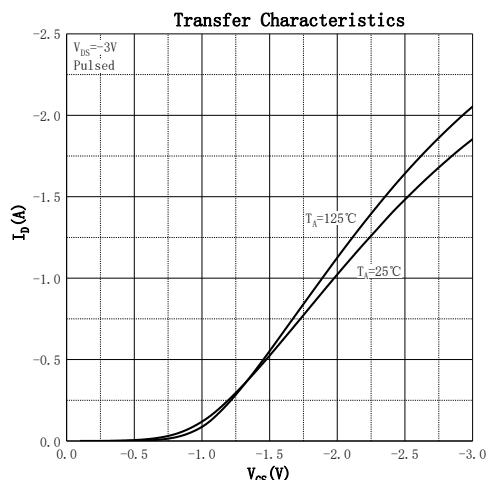
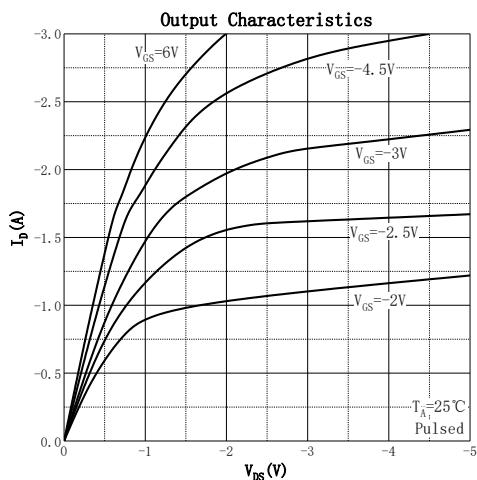
MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

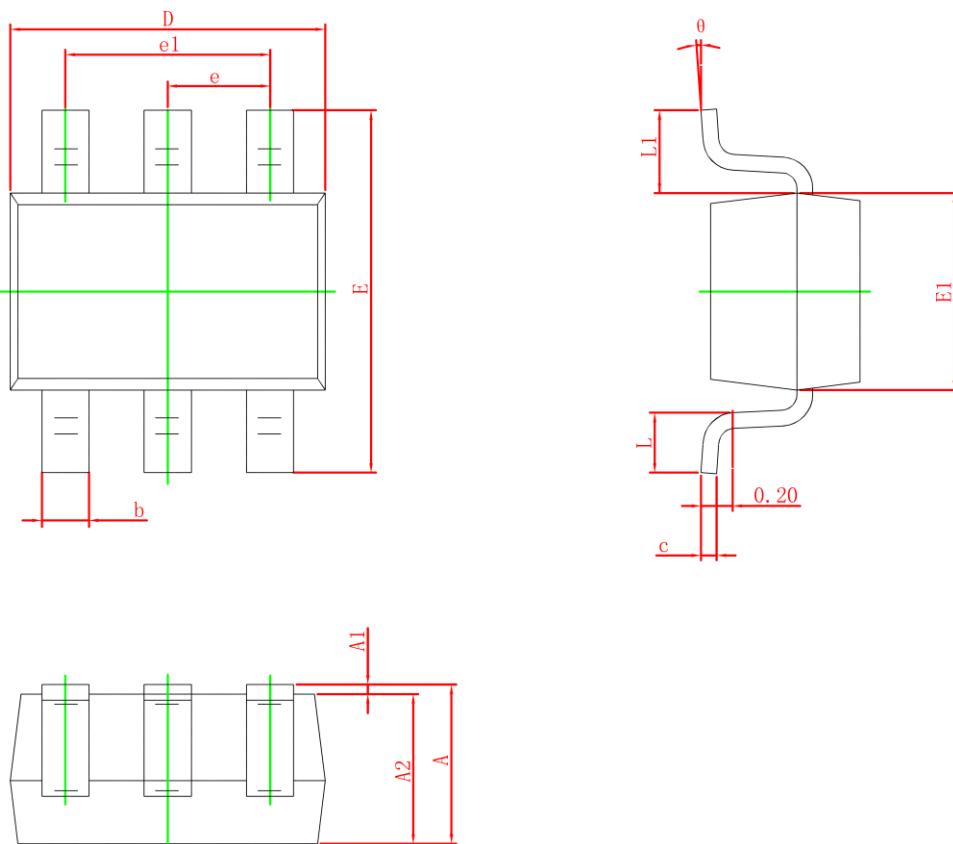
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -16\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			± 10	μA
On Characteristics³						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.4	-0.7	-1.0	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -0.5\text{A}$		400	520	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -0.3\text{A}$		570	780	
		$V_{\text{GS}} = -1.8\text{V}, I_D = -0.12\text{A}$		810	1100	
Forward Transconductance	g_{FS}	$V_{\text{DS}} = -5\text{V}, I_D = -0.4\text{A}$		1		S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		79		pF
Output Capacitance	C_{oss}			15		
Reverse Transfer Capacitance	C_{rss}			13		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -0.2\text{A}$		2.26		nC
Gate-source Charge	Q_{gs}			0.45		
Gate-drain Charge	Q_{gd}			0.24		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, R_L = 50\Omega, R_G = 3\Omega$		8		ns
Turn-on Rise Time	t_r			5.5		
Turn-off Delay Time	$t_{\text{d}(\text{off})}$			30		
Turn-off Fall Time	t_f			17		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = -0.5\text{A}$			1.2	V

Notes :

- 1.The maximum current rating is limited by package.
- 2.Repetitive rating:pulse width limited by $T_{J(\text{MAX})} = 150^\circ\text{C}$.
- 3.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 4.The power dissipation P_D is limited by $T_{J(\text{MAX})} = 150^\circ\text{C}$.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics



SOT-363 Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A1	0	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	1.800	2.200	0.071	0.087
E	2.000	2.450	0.079	0.096
E1	1.150	1.350	0.045	0.053
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L1	0.525 REF		0.021 REF	
L	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°